Contractor interview of the second se Consiglio Nazionale delle Ricerche

Deterministic doping: each atom counts!

Advanced Manufacturing Open Stakeholder Meeting, Turin, October 24, 2023

- Michele Perego
- CNR-IMM, Via Olivetti 2, Agrate Brianza, Italy







Research Activity

Si (100) —



Introducing self-assembly materials into conventional manufacturing processes to increase our capability to control matter at the nanoscale.

Homopolymer Random Coil

Dopant Containing Moiety







2. Deterministic Doping Strategies

- 2.1 Hydrogen-resist Lithography
- 2.2 Deterministic Ion Implantation
- 2.2 Alternative Doping Strategies

3. Detection of Isolated Impurit

- 3.1 Scanning Probes
- 3.2 STEM Techniques







Control gate

Diamond quantum optics. (Left) Electronic struc-ture of the NV center in clamond, showing the distribution of electron clouds. (Middle) High-resolution

NV center

g

O



Single atom devices have been successfully implemented, continuing the possibility to create novel functional devices exploiting quantum phenomena occurring at the atomic scale.

nature nanotechnology

A single-atom transistor

2018

LETTERS

Martin Fuechsle¹, Jill A. Miwa¹, Suddhasatta Mahapatra¹, Hoon Ryu², Sunhee Lee³, Oliver Warschkow⁴, Lloyd C. L. Hollenberg⁵, Gerhard Klimeck³ and Michelle Y. Simmons^{1*}















A silicon-based nuclear spin quantum computer

B. E. Kane

Semiconductor Manahilmisation Fueldity, School of Pitesia, University of New South Walls, Stalney 2053, Australia

NATURE | VOL 393 | 14 MAY 1998



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1. Introduction

Fabrication of scala the most stringent b promising platforms.



















2. Deterministic Doping Strategies

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Atomically Precise Placement of Single Dopants in Si

S. R. Schofield,^{*} N. J. Curson, M. Y. Simmons, F. J. Rueß, T. Hallam, L. Oberbeck, and R. G. Clark Centre for Quantum Computer Technology, School of Physics, University of New South Wales, Sydney, NSW 2052, Australia (Received 21 April 2003; published 25 September 2003)



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www.imm.cnr.it



2.1 Hydrogen-Resist Lithd

STM and hydrogen-resist lithograph place individual phosphorus dop epitaxial silicon device architec accuracy of one lattice site



LETTERS

PUBLISHED ONLINE: 19 FEBRUARY 2012 | DOI: 10.1038/NNANO.2012.21

A single-atom transistor

Martin Fuechsle¹, Jill A. Miwa¹, Suddhasatta Mahapatra¹, Hoon Ryu², Sunhee Lee³, Oliver Warschkow⁴, Lloyd C. L. Hollenberg⁵, Gerhard Klimeck³ and Michelle Y. Simmons^{1*}







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Sources **Conventional Stochastic Ion**



Decreasing the implantation energy it is possible to control the depth position of implanted impurities with sub



11

LETTERS

Enhancing semiconductor device performance using ordered dopant arrays

Takahiro Shinada¹, Shintaro Okamoto², Takahiro Kobayashi² & Iwao Ohdomari^{1,2}

nature

Vol 437120 October 2005



IOP PUBLISHING

Nanotechnology 24 (2013) 145304 (10pp)

Nanotechnology doi:10.1088/0957-4484/24/14/145304

Controlled deterministic implantation by nanostencil lithography at the limit of ion-aperture straggling

A D C Alves¹, J Newnham¹, J A van Donkelaar¹, S Rubanov², J C McCallum¹ and D N Jamieson¹



Integration of Scanning Probes and Ion Beams

A. Persaud,* S. J. Park, J. A. Liddle, and T. Schenkel

E. O. Lawrence Berkeley National Laboratory, Berkeley, California 94720

J. Bokor

E. O. Lawrence Berkeley National Laboratory, Berkeley, California 94720 and Department of Electrical Engineering and Computer Science, University of California, Berkeley, California 94720

I. W. Rangelow

Institute of Microstructure Technologies and Analytics, University of Kassel, Germany





2.2 Deterministic Ion Implantation

Control of lateral position of implanted impurities is possible using focused ion beams or broad beams through a focusing template











nr.it www.imm.cl

2.2 Deterministic Ion Implantation

Effective confinement of silicon atoms in localized nano-volumes by implanting Si⁺ ions at ULE in SiO₂ through a mesoporous polymeric template.













www.imm.cnr.it



Poisson's Tiranny

n	Probability
1	36.8%
2	13.5%
3	4.8%
5	0.66%
10	0.0045%

J. van Donkelaar et al., J. Phys. Condens. Matter 27, 154024 (2051)

2.2 Deterministic Ion Implantation

According to Poisson statistic, maximum probability of success in implanting one single ion (n = 1) per pore is 36.8%



True number *k* of implanted ions

Chains or arrays formed by *n* single implanted atoms can only be produced via deterministic implantation of counted single ions







REVIEW OF SCIENTIFIC INSTRUMENTS 88, 123301 (2017)

Ion implantation for deterministic single atom devices

J. L. Pacheco, M. Singh, D. L. Perry, J. R. Wendt, G. Ten Eyck, R. P. Manginell, T. Pluym, D. R. Luhman, M. P. Lilly, M. S. Carroll, and E. Bielejec Sandia National Laboratories, Albuquerque, New Mexico 87185, USA

IOP PUBLISHING

Nanotechnology 19 (2008) 345202 (4pp)

NANOTECHNOLOGY

doi:10.1088/0957-4484/19/34/345202

A reliable method for the counting and control of single ions for single-dopant **controlled devices**

T Shinada¹, T Kurosawa², H Nakayama², Y Zhu², M Hori² and

IOP Publishing

nr.it

www.imm.c

J. Phys.: Condens. Matter 27 (2015) 154204 (9pp)

Journal of Physics: Condensed Matter doi:10.1088/0953-8984/27/15/154204

Single atom devices by ion implantation

Jessica van Donkelaar¹, C Yang¹, A D C Alves^{1,3}, J C McCallum¹, C Hougaard¹, B C Johnson¹, F E Hudson², A S Dzurak², A Morello², D Spemann¹ and D N Jamieson¹

Interfa

Ce

Dam



Data demonstrate the successful creation of a non-Poisson distributed and the indication system,





Counts













Materials

www.MaterialsViews.com



Large-Area, Nanometer-Scale Discrete Doping of Semiconductors via Block Copolymer Self-Assembly

Bhooshan C. Popere, Boris Russ, Andrew T. Heitsch, Peter Trefonas, and Rachel A. Segalman*

Adv. Mater. Interfaces 2015, 2, 1500421

RESEARCH ARTICLE



Discrete, Shallow Doping of Semiconductors via Cylinder-Forming Block Copolymer Self-Assembly

Yuanyi Zhang, Scott P. O. Danielsen, Bhooshan C. Popere, Andrew T. Heitsch, Mingqi Li, Peter Trefonas, Rachel A. Segalman,* and Reika Katsumata*

Macromol. Mater. Eng. 2022, 2200155

ADVANCED 3 Alternative Doping Strategies







NAN 🛇 Cite This: ACS Nano 2018, 12, 178–186

Control of Doping Level in Semiconductors via

(a) 25.4 kg/mol PMMA_n-P О 14.2 kg/mo Self-Limited Grafting of Phosphorus End-5.8 kg/mc PS_n-P 0 atoms/cm³) **Terminated Polymers** 2.3 kg/mo Michele Perego,^{*,†} Gabriele Seguini,[†] Elisa Arduca,^{†,‡} Andrea Nomellini,[‡] Katia Sparnacci,^{*,§} Diego Antonioli,[§] Valentina Gianotti,[§] and Michele Laus[§] concentration (x10²⁰ [‡]Università degli Studi di Milano, Via G. Celoria 16, I-20133 Milano, Italy [§]Università del Piemonte Orientale "A. Avogadro", Viale T. Michel 11, I-15121 Alessandria, Italy Homopolymer Random Coil 12 Grafting 10 ۵. Film thickness (nm) ensity Dopant Containing Moiety 2 3 12 8 Σ (x 10¹³ chains/cm²) Depth (nm) 0 chains Polymeric chains are sacrificial elements acting as

25

[†]Laboratorio MDM, IMM-CNR, Via C. Olivetti 2, I-20864 Agrate Brianza, Italy



www.imm.c

2.3 Alternative Doping Strategies

spacers to tune the grafting density of the dopant containing moieties

Dopant containing moieties serve as dopant carriers to effectively deliver dopant atoms onto silicon surfaces

















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NANO REVIEW

Open Access

Atom devices based on single dopants in silicon nanostructures

Daniel Moraru¹, Arief Udhiarto¹, Miftahul Anwar¹, Roland Nowak^{1,2}, Ryszard Jablonski², Earfan Hamid¹, Juli Cha Tarido¹, Takeshi Mizuno¹ and Michiharu Tabe^{1*}



M. Ligowski et al., Appl Phys Lett 93,142101 (2008) M. Tabe *et al.*, Thin Solid Films 518, S38-S43 (2010) D. Moraru *et al.*, Nanoscale Research Letters 6, 479 (2011)



3.1 Scanning Probes

Using our low-temperature (LT)-KFM technique, the discrete distribution of P donors in the channel of thin SOI-FETs is observed as electronic potential maps











I.M Ross et al., Journal of Physics: Conference Series 371 (2012) 012013

3.2 STEM Techniques

Aberration corrected STEM techniques achieved elemental compositional maps and profiles with atomiccolumn resolution

D.Hernández-Maldonado et al., Microscopy and Microanalysis, 17 (4), 578–581, (2011)



Michelle A. Smeaton et al., *Nano Lett.* 2023, 23, 6393–6398













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4. Conclusions

Deterministic Doping Strategies

The development of deterministic doping techniques represents a big chance for material scientists and engineers to develop a new generation of atomic scale devices

Scanning tunneling lithography and single ion implantation technologies have been demonstrated to guarantee control of dopant position

New doping strategies based on self-assembling materials have been proposed as an alternative approach to achieve deterministic doping

Metrology Challenge

Detection of impurity atoms within a semiconductor with atomic resolution represents a formidable challenge for metrology











